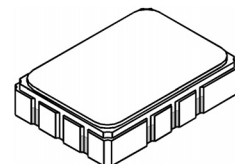


- **Designed for SDARS IF Receiver**
- **Low Insertion Loss**
- **5.0 X 7.0 mm Surface-Mount Case**
- **Differential or Single Ended Input and Output**
- **Complies with Directive 2002/95/EC (RoHS)**
- **Moisture Sensitivity Level: 1**
- **AEC-Q200 Qualified**

SF2037B-2

**76.500 MHz
SAW Filter**



SMP-03

Absolute Maximum Ratings

Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
Max. DC voltage between any 2 terminals	30	VDC
Storage Temperature Range (with tape & reel)	-40 to +85	°C
Storage Temperature Range (without tape & reel)	-50 to +125	°C
Max Soldering Profile	265°C for 10 s	

Electrical Characteristics

Characteristic	Sym	Notes	Min	Typ	Max	Units
Nominal Center Frequency	f_c			76.500		MHz
Passband	Insertion Loss	IL		10.0	12.5	dB
	1dB Passband	BW ₁	3.8	4.1		MHz
	15dB Bandwidth	BW ₁₅		6.7	6.8	MHz
	30dB Bandwidth	BW ₃₀		7.7	7.8	MHz
	Amplitude Ripple over $f_c \pm 1.9$ MHz			0.5	1.10	dB _{p-p}
	Group Delay Variation over $f_c \pm 1.9$ MHz	GDV		65	150	ns _{p-p}
Rejection	50 to 70.44 MHz		37	43		dB
	70.44 to 72.04 MHz		34	43		
	81.26 to 82.56 MHz		38	49		
	82.56 to 86.50 MHz		39	48		
	86.5 to 91.50 MHz		41	48		
	91.50 to 100.000 MHz		45	58		
Operating Temperature Range	T _A		-40		+105	°C
Frequency Temperature Coefficient	FTC			-18		ppm/°C
Differential Input			175 ohms			
Differential Output			1000 ohms			
Case Style			SMP-03 7 x 5 mm Nominal Footprint			
Lid Symbolization (YY=year, WW=week, S=shift, ## = Sequence Code)			RFM SF2037B-2 YYWWS##			

Electrical Connections

Connection	Terminals
Port 1 Hot	10
Port 1 Ground Return	1
Port 2 Hot	5
Port 2 Ground Return	6
Case Ground	All Others



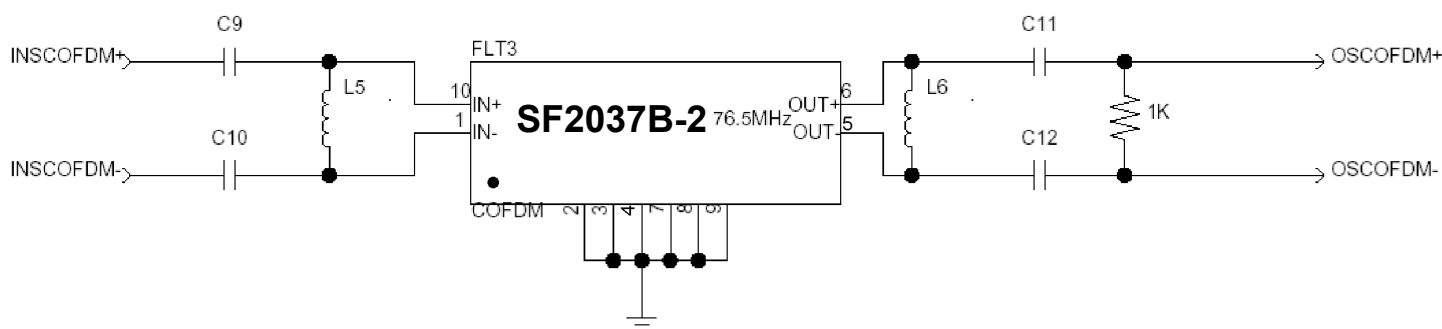
CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

NOTES:

1. The design, manufacturing process, and specifications of this device are subject to change.
2. US or International patents may apply.
3. RoHS compliant from the first date of manufacture.

Matching Circuit and Matching Component Values Used in G3 Sirius Radios

(Refer to Sirius Radio G3 Chipset Application Note, Doc. #RX000104-B, Sec. 4.2.4)

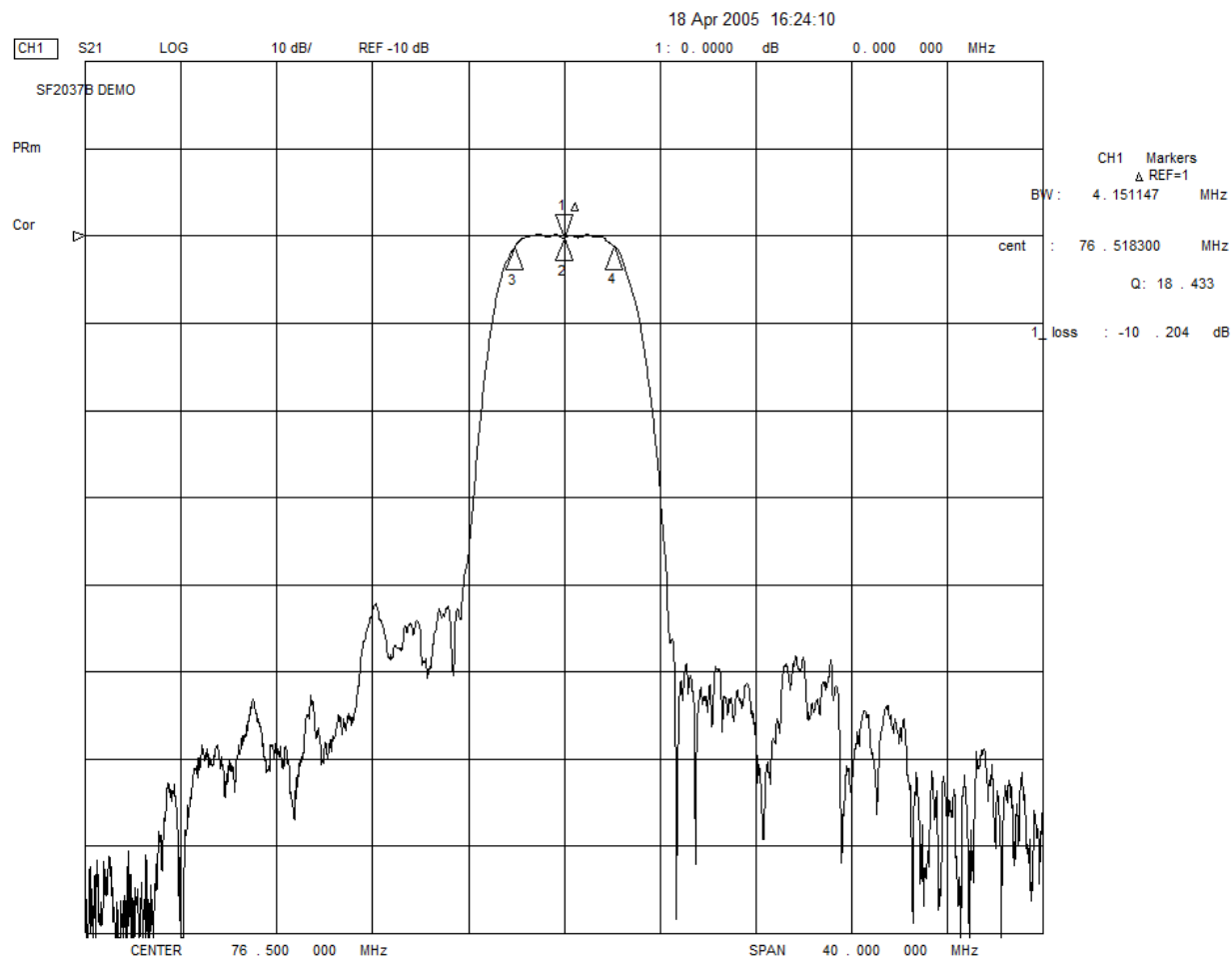
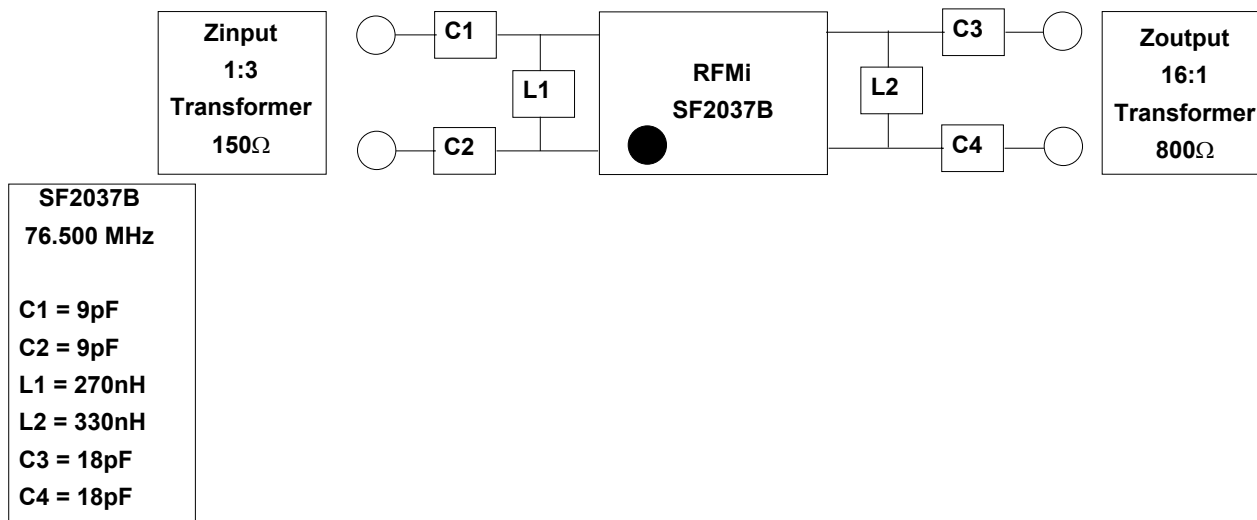


COFDM Narrowband SAW Matching Circuit

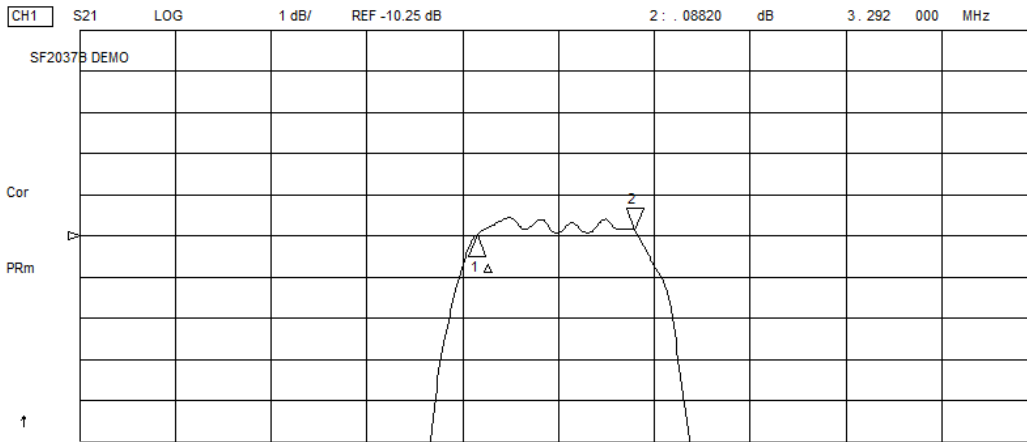
COFDM Narrowband SAW Matching Values

Reference Designator	Value
C9	10 pF
C10	10 pF
L5	270 nH
L6	390 nH
C11	100 pF
C12	100 pF

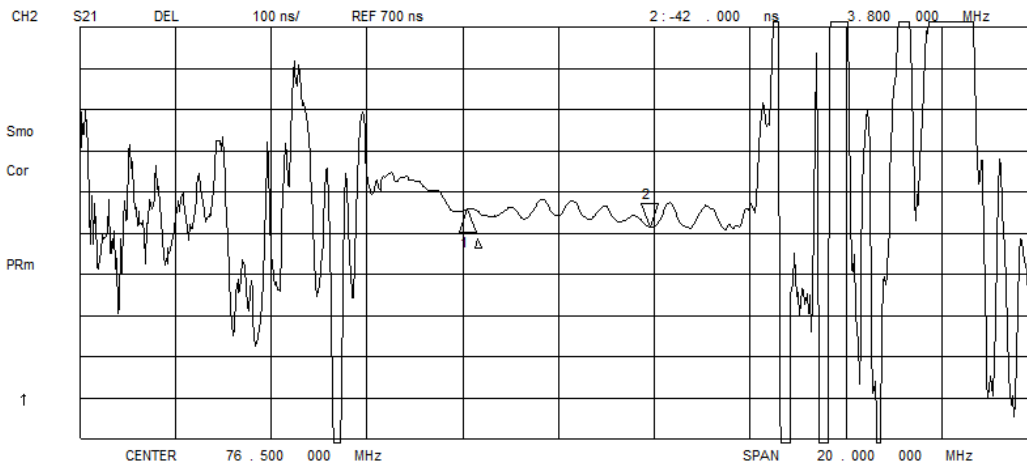
Matching Circuit and Matching Component Values Used on Filter Demo Board



18 Apr 2005 16:18:31



CH1 Markers
 Δ REF=1
 mean : -10 . 015 dB
 s. dev : . 10870 dB
 p-p : . 41040 dB

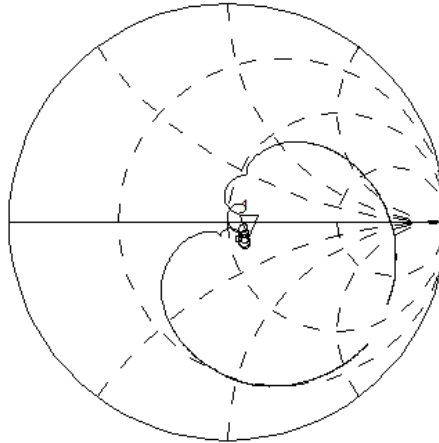


CH2 Markers
 Δ REF=1
 mean : 748 . 87 ns
 s. dev : 14 . 984 ns
 p-p : 65 . 994 ns

18 Apr 2005 16:28:43
 CH1 S11 1 UFS 1: 59.928 $\angle$ -9.8086 $\angle$ 212.11 pF 76.500 000 MHz
 SF2037B DEMO

Cor

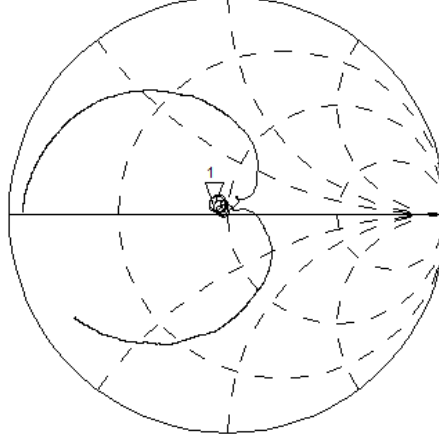
PRm



CH2 S22 1 UFS 1: 43.949 $\angle$ 3.1992 $\angle$ 6.6558 nH 76.500 000 MHz

Cor

PRm



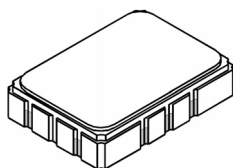
CENTER 76.500 000 MHz

SPAN 40.000 000 MHz

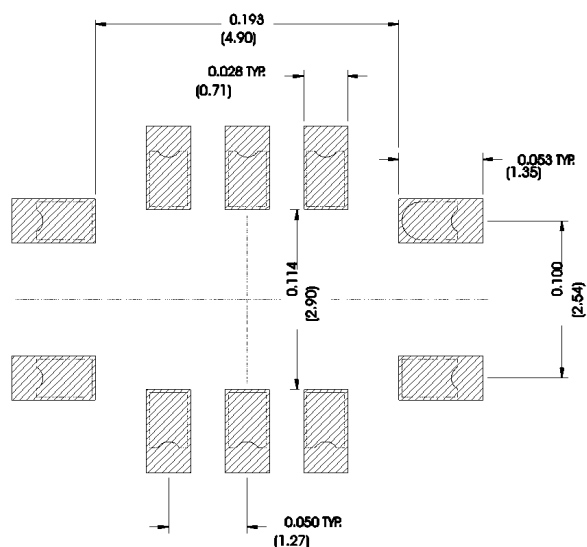
SMP-03 Case

10-Terminal Ceramic Surface-Mount Case

7 x 5 mm Nominal Footprint



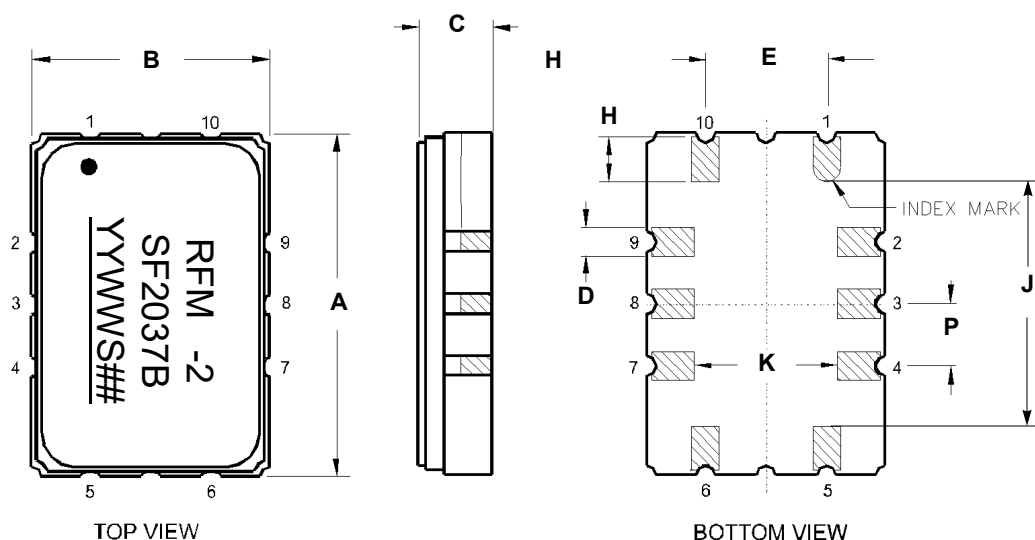
Recommended PCB Footprint



Case Dimensions						
Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	6.80	7.00	7.20	0.268	0.276	0.283
B	4.80	5.00	5.20	0.189	0.197	0.205
C		1.65	2.00		0.065	0.079
D	.47	0.60	.73	0.019	0.024	0.029
E	2.41	2.54	2.67	0.095	0.100	0.105
H	0.87	1.0	1.13	0.034	0.039	0.044
J	4.87	5.00	5.13	0.192	0.197	0.202
K	2.87	3.00	3.13	0.113	0.118	0.123
P	1.14	1.27	1.40	0.045	0.050	0.055

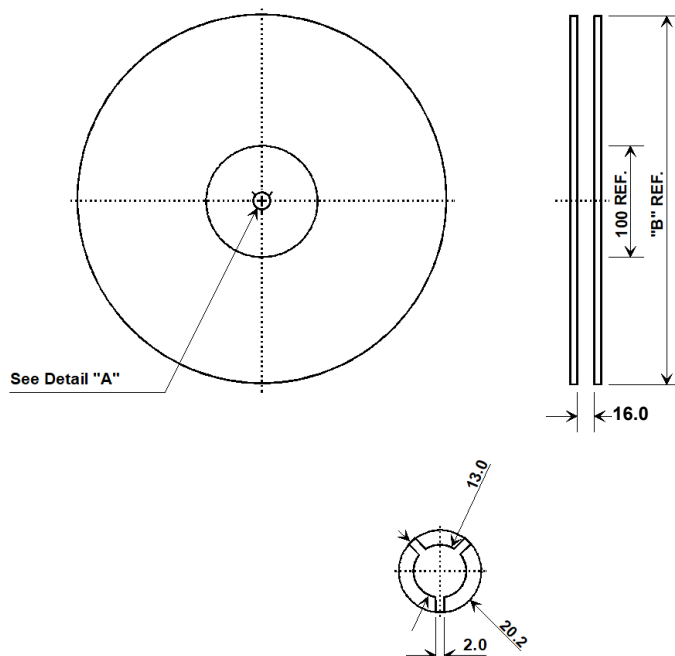
Materials	
Solder Pad Termination	Au plating 30 - 60 ulnches (76.2-152 uM) over 80-200 ulnches (203-508 uM) Ni.
Lid	Fe-Ni-Co Alloy Electroless Nickel Plate (8-11% Phosphorus) 100-200 ulnches Thick
Body	Al ₂ O ₃ Ceramic

Electrical Connections		
Connection		Terminals
Port 1	Input or Return	10
	Return or Input	1
Port 2	Output or Return	5
	Return or Output	6
Ground		All others
Single Ended Operation		Return is ground
Differential Operation		Return is hot



Tape and Reel Specifications

Tape and Reel Standard per ANSI/EIA-481

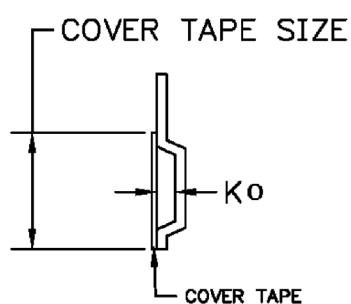


"B" Nominal Size		Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	2000

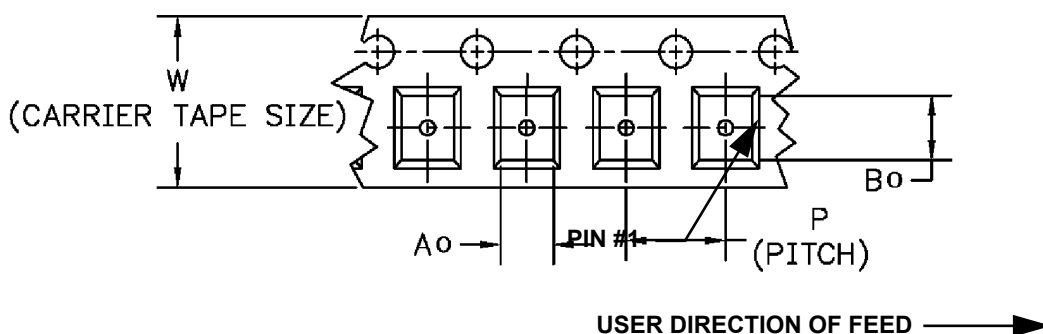
Product Reflow/ESD

Reflow Peak Temperature	265	°C
Reflow Peak Time	10	Seconds
Liquidus 217 Temperature/Time	110	Seconds
Over Liquidus 230 Temperature/Time	70	Seconds
Reflow Condition	SMT	
Class Level HBM	2	
HBM(V)	2000	HBM(V)
MM(V)	N/A	MM(V)
CDM(V)	2000	CDM(V)

COMPONENT ORIENTATION and DIMENSIONS



Carrier Tape Dimensions	
Ao	5.5 mm
Bo	7.5 mm
Ko	2.0 mm
Pitch	8.0 mm
W	16.0 mm



Recommended Reflow Profile

1. Preheating shall be fixed at 150~180°C for 60~90 seconds.
2. Ascending time to preheating temperature 150°C shall be 30 seconds min.
3. Heating shall be fixed at 220°C for 50~80 seconds and at 260°C+0/-5°C peak (10 seconds).
4. Time: 5 times maximum.

